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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	M32C/80
Core Size	16/32-Bit
Speed	32MHz
Connectivity	CANbus, I ² C, IEBus, SIO, UART/USART
Peripherals	DMA, WDT
Number of I/O	121
Program Memory Size	320KB (320K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	24K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 34x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LFQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m30855fwgp-u5

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1.2 Performance Overview

Tables 1.1 and 1.2 list performance overview of the M32C/85 group (M32C/85, M32C/85T).

Table 1.1 M32C/85 Group (M32C/85, M32C/85T) Performance (144-Pin Package)

Characteristic		Performance	
		M32C/85	M32C/85T
CPU	Basic Instructions	108 instructions	
	Minimum Instruction Execution Time	31.3 ns (f(BCLK)=32 MHz, Vcc1=4.2 V to 5.5 V) 41.7 ns (f(BCLK)=24 MHz, Vcc1=3.0 V to 5.5 V)	31.3 ns (f(BCLK)=32 MHz, Vcc1=4.2 V to 5.5 V)
	Operating Mode	Single-chip mode, Memory expansion mode and Microprocessor mode	Single-chip mode
	Address Space	16 Mbytes	
	Memory Capacity	See Table 1.3	
Peripheral Function	I/O Port	123 I/O pins and 1 input pin	
	Multifunction Timer	Timer A: 16 bits x 5 channels, Timer B: 16 bits x 6 channels Three-phase motor control circuit	
	Intelligent I/O	Time measurement function or Waveform generating function: 16 bits x 8 channels Communication function (Clock synchronous serial I/O, Clock asynchronous serial I/O, HDLC data processing)	
	Serial I/O	5 Channels Clock synchronous serial I/O, Clock asynchronous serial I/O, IEBus ⁽¹⁾ , I ² C bus ⁽²⁾	
	CAN Module	2 channels Supporting CAN 2.0B specification	
	A/D Converter	10-bit A/D converter: 1 circuit, 34 channels	
	D/A Converter	8 bits x 2 channels	
	DMAC	4 channels	
	DMAC II	Can be activated by all peripheral function interrupt sources Immediate transfer, Calculation transfer and Chain transfer functions	
	CRC Calculation Circuit	CRC-CCITT	
	X/Y Converter	16 bits x 16 bits	
	Watchdog Timer	15 bits x 1 channel (with prescaler)	
	Interrupt	39 internal and 8 external sources, 5 software sources Interrupt priority level: 7	
	Clock Generation Circuit	4 circuits Main clock oscillation circuit(*), Sub clock oscillation circuit(*), On-chip oscillator, PLL frequency synthesizer (*)Equipped with a built-in feedback resistor. Ceramic resonator or crystal oscillator must be connected externally	
	Oscillation Stop Detect Function	Main clock oscillation stop detect function	
	Voltage Detection Circuit	Available (optional)	Not available ⁽⁴⁾
Electrical Characteristics	Supply Voltage	Vcc1=4.2 V to 5.5 V, Vcc2=3.0 V to Vcc1 (f(BCLK)=32 MHz) Vcc1=3.0 V to 5.5 V, Vcc2=3.0 V to Vcc1 (f(BCLK)=24 MHz)	Vcc1=Vcc2=4.2 V to 5.5 V, (f(BCLK)=32 MHz) ⁽³⁾
	Power Consumption	28 mA (Vcc1=Vcc2=5 V, f(BCLK)=32 MHz) 22 mA (Vcc1=Vcc2=3.3 V, f(BCLK)=24 MHz) 10μA (Vcc1=Vcc2=5 V, f(BCLK)=32 kHz, in wait mode)	28 mA (Vcc1=Vcc2=5 V, f(BCLK)=32 MHz) 10μA (Vcc1=Vcc2=5 V, f(BCLK)=32 kHz, in wait mode)
Flash Memory	Program/Erase Supply Voltage	3.3 V ± 0.3 V or 5.0 V ± 0.5 V	
	Program and Erase Endurance	100 times (all space)	
Operating Ambient Temperature		-20 to 85°C -40 to 85°C (optional)	-40 to 85°C (T version)
Package		144-pin plastic molded LQFP	

NOTES:

1. IEBus is a trademark of NEC Electronics Corporation.
2. I²C bus is a trademark of Koninklijke Philips Electronics N. V.
3. The supply voltage of M32C/85T (High-reliability version) must be Vcc1=Vcc2.
4. The cold start-up/warm start-up determine function is available only at the user's option.

All options are on a request basis.

Table 1.2 M32C/85 Group (M32C/85, M32C/85T) Performance (100-Pin Package)

Characteristic		Performance	
		M32C/85	M32C/85T
CPU	Basic Instructions	108 instructions	
	Minimum Instruction Execution Time	31.3 ns (f(BCLK)=32 MHz, Vcc1=4.2 V to 5.5 V) 41.7 ns (f(BCLK)=24 MHz, Vcc1=3.0 V to 5.5 V)	31.3 ns (f(BCLK)=32 MHz, Vcc1=4.2 V to 5.5 V)
	Operating Mode	Single-chip mode, Memory expansion mode and Microprocessor mode	Single-chip mode
	Address Space	16 Mbytes	
	Memory Capacity	See Table 1.3	
Peripheral Function	I/O Port	87 I/O pins and 1 input pin	
	Multifunction Timer	Timer A: 16 bits x 5 channels, Timer B: 16 bits x 6 channels Three-phase motor control circuit	
	Intelligent I/O	Time measurement function or Waveform generating function: 16 bits x 8 channels Communication function (Clock synchronous serial I/O, Clock asynchronous serial I/O, HDLC data processing)	
	Serial I/O	5 Channels Clock synchronous serial I/O, Clock asynchronous serial I/O, IEBus ⁽¹⁾ , I ² C bus ⁽²⁾	
	CAN Module	2 channels Supporting CAN 2.0B specification	
	A/D Converter	10-bit A/D converter: 1 circuit, 26 channels	
	D/A Converter	8 bits x 2 channels	
	DMAC	4 channels	
	DMAC II	Can be activated by all peripheral function interrupt sources Immediate transfer, Calculation transfer and Chain transfer functions	
	CRC Calculation Circuit	CRC-CCITT	
	X/Y Converter	16 bits x 16 bits	
	Watchdog Timer	15 bits x 1 channel (with prescaler)	
	Interrupt	39 internal and 8 external sources, 5 software sources Interrupt priority level: 7	
	Clock Generation Circuit	4 circuits Main clock oscillation circuit(*), Sub clock oscillation circuit(*), On-chip oscillator, PLL frequency synthesizer (*)Equipped with a built-in feedback resistor. Ceramic resonator or crystal oscillator must be connected externally	
	Oscillation Stop Detect Function	Main clock oscillation stop detect function	
	Voltage Detection Circuit	Available (optional)	Not available ⁽⁴⁾
Electrical Characteristics	Supply Voltage	Vcc1=4.2 V to 5.5 V, Vcc2=3.0 V to Vcc1 (f(BCLK)=32 MHz) Vcc1=3.0 V to 5.5 V, Vcc2=3.0 V to Vcc1 (f(BCLK)=24 MHz)	Vcc1=Vcc2=4.2 V to 5.5 V, (f(BCLK)=32 MHz) ⁽³⁾
	Power Consumption	28 mA (Vcc1=Vcc2=5 V, f(BCLK)=32 MHz) 22 mA (Vcc1=Vcc2=3.3 V, f(BCLK)=24 MHz) 10μA (Vcc1=Vcc2=5 V, f(BCLK)=32 kHz, in wait mode)	28 mA (Vcc1=Vcc2=5 V, f(BCLK)=32 MHz) 10μA (Vcc1=Vcc2=5 V, f(BCLK)=32 kHz, in wait mode)
Flash Memory	Program/Erase Supply Voltage	3.3 V ± 0.3 V or 5.0 V ± 0.5 V	
	Program and Erase Endurance	100 times (all space)	
Operating Ambient Temperature		-20 to 85°C -40 to 85°C (optional)	-40 to 85°C (T version)
Package		100-pin plastic molded LQFP/QFP	

NOTES:

1. IEBus is a trademark of NEC Electronics Corporation.
2. I²C bus is a trademark of Koninklijke Philips Electronics N. V.
3. The supply voltage of M32C/85T (High-reliability version) must be Vcc1=Vcc2.
4. The cold start-up/warm start-up determine function is available only at the user's option.

All options are on a request basis.

1.3 Block Diagram

Figure 1.1 shows a block diagram of the M32C/85 group (M32C/85, M32C/85T) microcomputer.

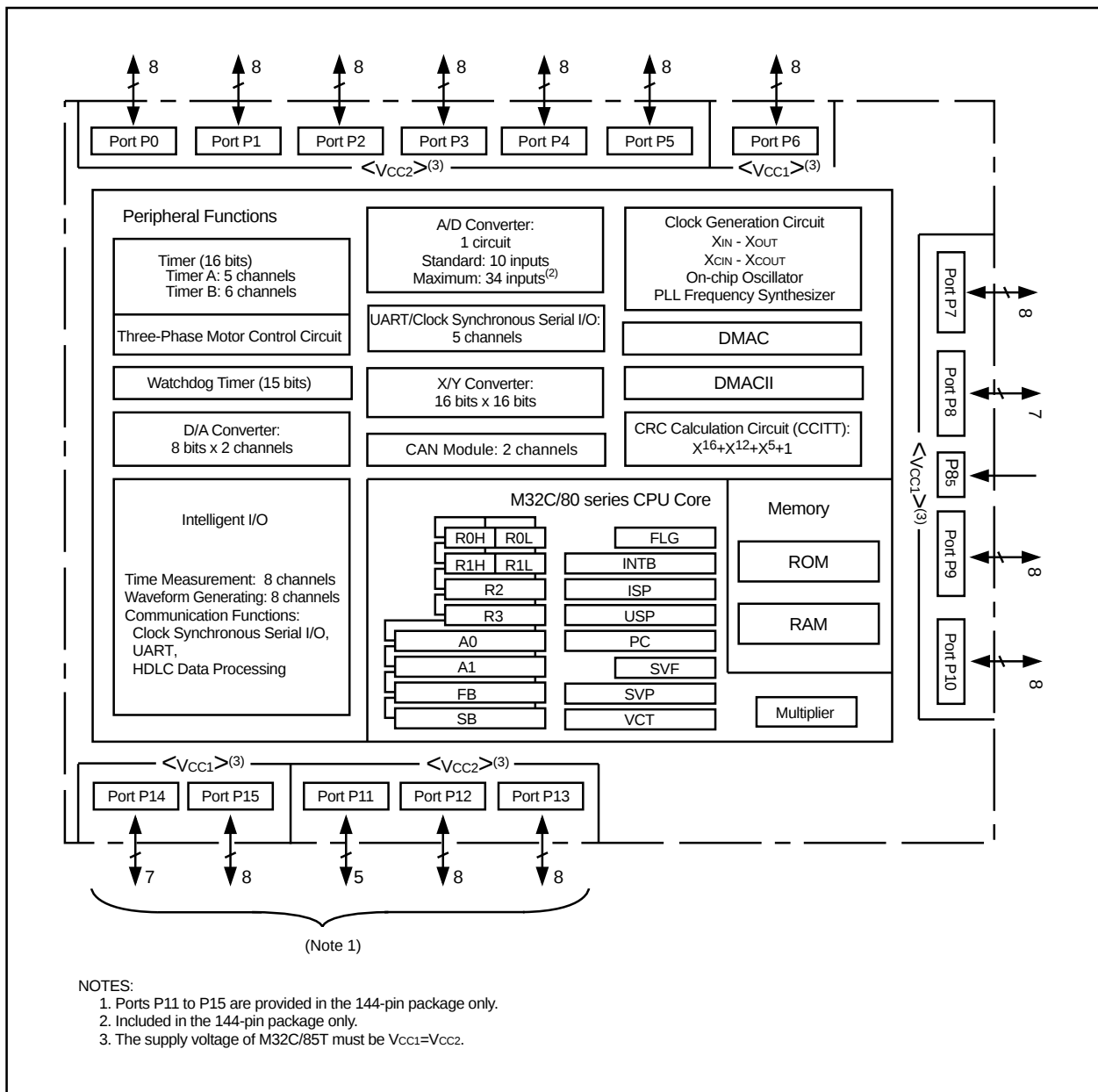


Figure 1.1 M32C/85 Group (M32C/85, M32C/85T) Block Diagram

1.5 Pin Assignments and Descriptions

Figures 1.3 to 1.5 show pin assignments (top view).

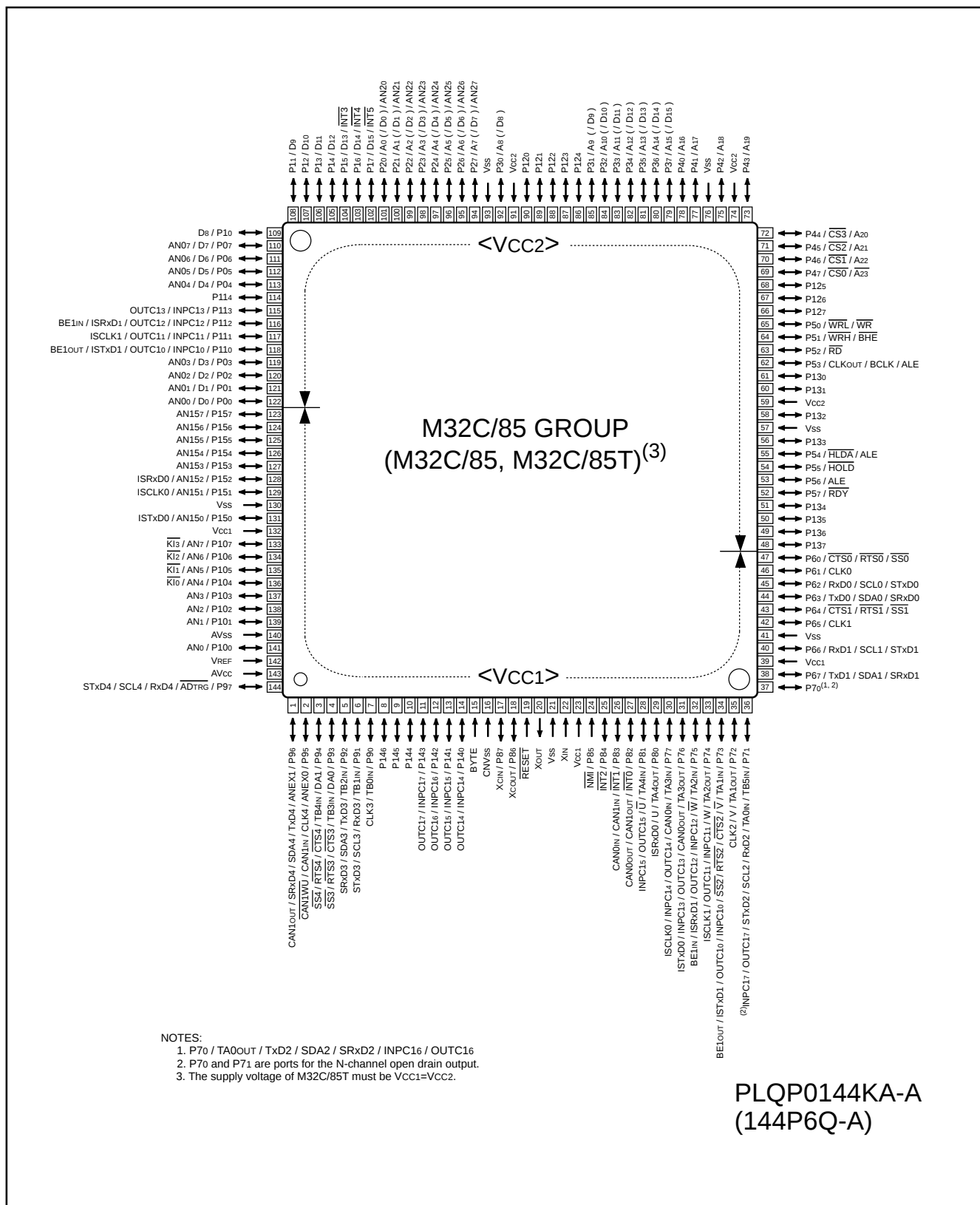


Figure 1.3 Pin Assignment for 144-Pin Package

Table 1.4 Pin Characteristics for 144-Pin Package (Continued)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART/CAN Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin ⁽¹⁾
97		P24					AN24	A4(/D4)
98		P23					AN23	A3(/D3)
99		P22					AN22	A2(/D2)
100		P21					AN21	A1(/D1)
101		P20					AN20	A0(/D0)
102		P17	INT5					D15
103		P16	INT4					D14
104		P15	INT3					D13
105		P14						D12
106		P13						D11
107		P12						D10
108		P11						D9
109		P10						D8
110		P07					AN07	D7
111		P06					AN06	D6
112		P05					AN05	D5
113		P04					AN04	D4
114		P114						
115		P113				INPC13/OUTC13		
116		P112				INPC12/OUTC12/ISRxD1/BE1IN		
117		P111				INPC11/OUTC11/ISCLK1		
118		P110				INPC10/OUTC10/ISTxD1/BE1OUT		
119		P03					AN03	D3
120		P02					AN02	D2
121		P01					AN01	D1
122		P00					AN00	D0
123		P157					AN157	
124		P156					AN156	
125		P155					AN155	
126		P154					AN154	
127		P153					AN153	
128		P152				ISRxD0	AN152	
129		P151				ISCLK0	AN151	
130	Vss							
131		P150				ISTxD0	AN150	
132	VCC1							
133		P107	KI3				AN7	
134		P106	KI2				AN6	
135		P105	KI1				AN5	
136		P104	KI0				AN4	
137		P103					AN3	
138		P102					AN2	
139		P101					AN1	
140	AVss							
141		P100					AN0	
142	VREF							
143	AVCC							
144		P97			RxD4/SCL4/STxD4		ADTRG	

NOTES:

1. Bus control pins in M32C/85T cannot be used,

2.1 General Registers

2.1.1 Data Registers (R0, R1, R2 and R3)

R0, R1, R2 and R3 are 16-bit registers for transfer, arithmetic and logic operations. R0 and R1 can be split into high-order bits (R0H) and low-order bits (R0L) to be used separately as 8-bit data registers. R0 can be combined with R2 to be used as a 32-bit data register (R2R0). The same applies to R1 and R3.

2.1.2 Address Registers (A0 and A1)

A0 and A1 are 24-bit registers for A0-/A1-indirect addressing, A0-/A1-relative addressing, transfer, arithmetic and logic operations.

2.1.3 Static Base Register (SB)

SB is a 24-bit register for SB-relative addressing.

2.1.4 Frame Base Register (FB)

FB is a 24-bit register for FB-relative addressing.

2.1.5 Program Counter (PC)

PC, 24 bits wide, indicates the address of an instruction to be executed.

2.1.6 Interrupt Table Register (INTB)

INTB is a 24-bit register indicating the starting address of an relocatable interrupt vector table.

2.1.7 User Stack Pointer (USP), Interrupt Stack Pointer (ISP)

The stack pointers (SP), USP and ISP, are 24 bits wide each. The U flag is used to switch between USP and ISP. Refer to **2.1.8 Flag Register (FLG)** for details on the U flag. Set USP and ISP to even addresses to execute an interrupt sequence efficiently.

2.1.8 Flag Register (FLG)

FLG is a 16-bit register indicating a CPU state.

2.1.8.1 Carry Flag (C)

The C flag indicates whether carry or borrow has occurred after executing an instruction.

2.1.8.2 Debug Flag (D)

The D flag is for debug only. Set to "0".

2.1.8.3 Zero Flag (Z)

The Z flag is set to "1" when the value of zero is obtained from an arithmetic operation; otherwise "0".

2.1.8.4 Sign Flag (S)

The S flag is set to "1" when a negative value is obtained from an arithmetic operation; otherwise "0".

Address	Register	Symbol	Value after RESET
0060 ₁₆			
0061 ₁₆			
0062 ₁₆			
0063 ₁₆			
0064 ₁₆			
0065 ₁₆			
0066 ₁₆			
0067 ₁₆			
0068 ₁₆	DMA0 Interrupt Control Register	DM0IC	XXXX X000 ₂
0069 ₁₆	Timer B5 Interrupt Control Register	TB5IC	XXXX X000 ₂
006A ₁₆	DMA2 Interrupt Control Register	DM2IC	XXXX X000 ₂
006B ₁₆	UART2 Receive /ACK Interrupt Control Register	S2RIC	XXXX X000 ₂
006C ₁₆	Timer A0 Interrupt Control Register	TA0IC	XXXX X000 ₂
006D ₁₆	UART3 Receive /ACK Interrupt Control Register	S3RIC	XXXX X000 ₂
006E ₁₆	Timer A2 Interrupt Control Register	TA2IC	XXXX X000 ₂
006F ₁₆	UART4 Receive /ACK Interrupt Control Register	S4RIC	XXXX X000 ₂
0070 ₁₆	Timer A4 Interrupt Control Register	TA4IC	XXXX X000 ₂
0071 ₁₆	UART0/UART3 Bus Conflict Detect Interrupt Control Register	BCN0IC/BCN3IC	XXXX X000 ₂
0072 ₁₆	UART0 Receive/ACK Interrupt Control Register	S0RIC	XXXX X000 ₂
0073 ₁₆	A/D0 Conversion Interrupt Control Register	AD0IC	XXXX X000 ₂
0074 ₁₆	UART1 Receive/ACK Interrupt Control Register	S1RIC	XXXX X000 ₂
0075 ₁₆	Intelligent I/O Interrupt Control Register 0/ CAN Interrupt 3 Control Register	IIO0IC/ CAN3IC	XXXX X000 ₂
0076 ₁₆	Timer B1 Interrupt Control Register	TB1IC	XXXX X000 ₂
0077 ₁₆	Intelligent I/O Interrupt Control Register 2	IIO2IC	XXXX X000 ₂
0078 ₁₆	Timer B3 Interrupt Control Register	TB3IC	XXXX X000 ₂
0079 ₁₆	Intelligent I/O Interrupt Control Register 4	IIO4IC	XXXX X000 ₂
007A ₁₆	INT5 Interrupt Control Register	INT5IC	XX00 X000 ₂
007B ₁₆			
007C ₁₆	INT3 Interrupt Control Register	INT3IC	XX00 X000 ₂
007D ₁₆	Intelligent I/O Interrupt Control Register 8	IIO8IC	XXXX X000 ₂
007E ₁₆	INT1 Interrupt Control Register	INT1IC	XX00 X000 ₂
007F ₁₆	Intelligent I/O Interrupt Control Register 10/ CAN Interrupt 1 Control Register	IIO10IC/ CAN1IC	XXXX X000 ₂
0080 ₁₆			
0081 ₁₆	CAN Interrupt 2 Control Register	CAN2IC	XXXX X000 ₂
0082 ₁₆			
0083 ₁₆			
0084 ₁₆			
0085 ₁₆			
0086 ₁₆			
0087 ₁₆			
0088 ₁₆	DMA1 Interrupt Control Register	DM1IC	XXXX X000 ₂
0089 ₁₆	UART2 Transmit /NACK Interrupt Control Register	S2TIC	XXXX X000 ₂
008A ₁₆	DMA3 Interrupt Control Register	DM3IC	XXXX X000 ₂
008B ₁₆	UART3 Transmit /NACK Interrupt Control Register	S3TIC	XXXX X000 ₂
008C ₁₆	Timer A1 Interrupt Control Register	TA1IC	XXXX X000 ₂
008D ₁₆	UART4 Transmit /NACK Interrupt Control Register	S4TIC	XXXX X000 ₂
008E ₁₆	Timer A3 Interrupt Control Register	TA3IC	XXXX X000 ₂
008F ₁₆	UART2 Bus Conflict Detect Interrupt Control Register	BCN2IC	XXXX X000 ₂

X: Indeterminate

Blank spaces are reserved. No access is allowed.

Address	Register	Symbol	Value after RESET
00F0 ₁₆	Data Compare Register 00	G0CMP0	XX ₁₆
00F1 ₁₆	Data Compare Register 01	G0CMP1	XX ₁₆
00F2 ₁₆	Data Compare Register 02	G0CMP2	XX ₁₆
00F3 ₁₆	Data Compare Register 03	G0CMP3	XX ₁₆
00F4 ₁₆	Data Mask Register 00	G0MSK0	XX ₁₆
00F5 ₁₆	Data Mask Register 01	G0MSK1	XX ₁₆
00F6 ₁₆	Communication Clock Select Register	CCS	XXXX 0000 ₂
00F7 ₁₆			
00F8 ₁₆	Receive CRC Code Register 0	G0RCRC	XX ₁₆
00F9 ₁₆			XX ₁₆
00FA ₁₆	Transmit CRC Code Register 0	G0TCRC	00 ₁₆
00FB ₁₆			00 ₁₆
00FC ₁₆	SI/O Extended Mode Register 0	G0EMR	00 ₁₆
00FD ₁₆	SI/O Extended Receive Control Register 0	G0ERC	00 ₁₆
00FE ₁₆	SI/O Special Communication Interrupt Detect Register 0	G0IRF	00 ₁₆
00FF ₁₆	SI/O Extended Transmit Control Register 0	G0ETC	0000 0XXX ₂
0100 ₁₆	Time Measurement/Waveform Generating Register 10	G1TM0/G1PO0	XX ₁₆
0101 ₁₆			XX ₁₆
0102 ₁₆	Time Measurement/Waveform Generating Register 11	G1TM1/G1PO1	XX ₁₆
0103 ₁₆			XX ₁₆
0104 ₁₆	Time Measurement/Waveform Generating Register 12	G1TM2/G1PO2	XX ₁₆
0105 ₁₆			XX ₁₆
0106 ₁₆	Time Measurement/Waveform Generating Register 13	G1TM3/G1PO3	XX ₁₆
0107 ₁₆			XX ₁₆
0108 ₁₆	Time Measurement/Waveform Generating Register 14	G1TM4/G1PO4	XX ₁₆
0109 ₁₆			XX ₁₆
010A ₁₆	Time Measurement/Waveform Generating Register 15	G1TM5/G1PO5	XX ₁₆
010B ₁₆			XX ₁₆
010C ₁₆	Time Measurement/Waveform Generating Register 16	G1TM6/G1PO6	XX ₁₆
010D ₁₆			XX ₁₆
010E ₁₆	Time Measurement/Waveform Generating Register 17	G1TM7/G1PO7	XX ₁₆
010F ₁₆			XX ₁₆
0110 ₁₆	Waveform Generating Control Register 10	G1POCR0	0000 X000 ₂
0111 ₁₆	Waveform Generating Control Register 11	G1POCR1	0X00 X000 ₂
0112 ₁₆	Waveform Generating Control Register 12	G1POCR2	0X00 X000 ₂
0113 ₁₆	Waveform Generating Control Register 13	G1POCR3	0X00 X000 ₂
0114 ₁₆	Waveform Generating Control Register 14	G1POCR4	0X00 X000 ₂
0115 ₁₆	Waveform Generating Control Register 15	G1POCR5	0X00 X000 ₂
0116 ₁₆	Waveform Generating Control Register 16	G1POCR6	0X00 X000 ₂
0117 ₁₆	Waveform Generating Control Register 17	G1POCR7	0X00 X000 ₂
0118 ₁₆	Time Measurement Control Register 10	G1TMCR0	00 ₁₆
0119 ₁₆	Time Measurement Control Register 11	G1TMCR1	00 ₁₆
011A ₁₆	Time Measurement Control Register 12	G1TMCR2	00 ₁₆
011B ₁₆	Time Measurement Control Register 13	G1TMCR3	00 ₁₆
011C ₁₆	Time Measurement Control Register 14	G1TMCR4	00 ₁₆
011D ₁₆	Time Measurement Control Register 15	G1TMCR5	00 ₁₆
011E ₁₆	Time Measurement Control Register 16	G1TMCR6	00 ₁₆
011F ₁₆	Time Measurement Control Register 17	G1TMCR7	00 ₁₆

X: Indeterminate

Blank spaces are reserved. No access is allowed.

Address	Register	Symbol	Value after RESET
01E0 ₁₆	CAN0 Message Slot Buffer 0 Standard ID0	C0SLOT0_0	XX ₁₆
01E1 ₁₆	CAN0 Message Slot Buffer 0 Standard ID1	C0SLOT0_1	XX ₁₆
01E2 ₁₆	CAN0 Message Slot Buffer 0 Extended ID0	C0SLOT0_2	XX ₁₆
01E3 ₁₆	CAN0 Message Slot Buffer 0 Extended ID1	C0SLOT0_3	XX ₁₆
01E4 ₁₆	CAN0 Message Slot Buffer 0 Extended ID2	C0SLOT0_4	XX ₁₆
01E5 ₁₆	CAN0 Message Slot Buffer 0 Data Length Code	C0SLOT0_5	XX ₁₆
01E6 ₁₆	CAN0 Message Slot Buffer 0 Data 0	C0SLOT0_6	XX ₁₆
01E7 ₁₆	CAN0 Message Slot Buffer 0 Data 1	C0SLOT0_7	XX ₁₆
01E8 ₁₆	CAN0 Message Slot Buffer 0 Data 2	C0SLOT0_8	XX ₁₆
01E9 ₁₆	CAN0 Message Slot Buffer 0 Data 3	C0SLOT0_9	XX ₁₆
01EA ₁₆	CAN0 Message Slot Buffer 0 Data 4	C0SLOT0_10	XX ₁₆
01EB ₁₆	CAN0 Message Slot Buffer 0 Data 5	C0SLOT0_11	XX ₁₆
01EC ₁₆	CAN0 Message Slot Buffer 0 Data 6	C0SLOT0_12	XX ₁₆
01ED ₁₆	CAN0 Message Slot Buffer 0 Data 7	C0SLOT0_13	XX ₁₆
01EE ₁₆	CAN0 Message Slot Buffer 0 Time Stamp High-Order	C0SLOT0_14	XX ₁₆
01EF ₁₆	CAN0 Message Slot Buffer 0 Time Stamp Low-Order	C0SLOT0_15	XX ₁₆
01F0 ₁₆	CAN0 Message Slot Buffer 1 Standard ID0	C0SLOT1_0	XX ₁₆
01F1 ₁₆	CAN0 Message Slot Buffer 1 Standard ID1	C0SLOT1_1	XX ₁₆
01F2 ₁₆	CAN0 Message Slot Buffer 1 Extended ID0	C0SLOT1_2	XX ₁₆
01F3 ₁₆	CAN0 Message Slot Buffer 1 Extended ID1	C0SLOT1_3	XX ₁₆
01F4 ₁₆	CAN0 Message Slot Buffer 1 Extended ID2	C0SLOT1_4	XX ₁₆
01F5 ₁₆	CAN0 Message Slot Buffer 1 Data Length Code	C0SLOT1_5	XX ₁₆
01F6 ₁₆	CAN0 Message Slot Buffer 1 Data 0	C0SLOT1_6	XX ₁₆
01F7 ₁₆	CAN0 Message Slot Buffer 1 Data 1	C0SLOT1_7	XX ₁₆
01F8 ₁₆	CAN0 Message Slot Buffer 1 Data 2	C0SLOT1_8	XX ₁₆
01F9 ₁₆	CAN0 Message Slot Buffer 1 Data 3	C0SLOT1_9	XX ₁₆
01FA ₁₆	CAN0 Message Slot Buffer 1 Data 4	C0SLOT1_10	XX ₁₆
01FB ₁₆	CAN0 Message Slot Buffer 1 Data 5	C0SLOT1_11	XX ₁₆
01FC ₁₆	CAN0 Message Slot Buffer 1 Data 6	C0SLOT1_12	XX ₁₆
01FD ₁₆	CAN0 Message Slot Buffer 1 Data 7	C0SLOT1_13	XX ₁₆
01FE ₁₆	CAN0 Message Slot Buffer 1 Time Stamp High-Order	C0SLOT1_14	XX ₁₆
01FF ₁₆	CAN0 Message Slot Buffer 1 Time Stamp Low-Order	C0SLOT1_15	XX ₁₆
0200 ₁₆ 0201 ₁₆	CAN0 Control Register 0	C0CTRL0	XX01 0X01 ₂ ⁽¹⁾ XXXX 0000 ₂ ⁽¹⁾
0202 ₁₆ 0203 ₁₆	CAN0 Status Register	C0STR	0000 0000 ₂ ⁽¹⁾ X000 0X01 ₂ ⁽¹⁾
0204 ₁₆ 0205 ₁₆	CAN0 Extended ID Register	C0IDR	00 ₁₆ ⁽¹⁾ 00 ₁₆ ⁽¹⁾
0206 ₁₆ 0207 ₁₆	CAN0 Configuration Register	C0CONR	0000 XXXX ₂ ⁽¹⁾ 0000 0000 ₂ ⁽¹⁾
0208 ₁₆ 0209 ₁₆	CAN0 Time Stamp Register	C0TSR	00 ₁₆ ⁽¹⁾ 00 ₁₆ ⁽¹⁾
020A ₁₆	CAN0 Transmit Error Count Register	C0TEC	00 ₁₆ ⁽¹⁾
020B ₁₆	CAN0 Receive Error Count Register	C0REC	00 ₁₆ ⁽¹⁾
020C ₁₆ 020D ₁₆	CAN0 Slot Interrupt Status Register	C0SISTR	00 ₁₆ ⁽¹⁾ 00 ₁₆ ⁽¹⁾
020E ₁₆			
020F ₁₆			

X: Indeterminate

Blank spaces are reserved. No access is allowed.

NOTES:

- Values are obtained by setting the SLEEP bit in the C0SLPR register to "1" (sleep mode exited) after reset and applying the clock to the CAN module.

Address	Register	Symbol	Value after RESET
0210 ₁₆	CAN0 Slot Interrupt Mask Register	C0SIMKR	00 ₁₆ ⁽²⁾
0211 ₁₆			00 ₁₆ ⁽²⁾
0212 ₁₆			
0213 ₁₆			
0214 ₁₆	CAN0 Error Interrupt Mask Register	C0EIMKR	XXXX X000 ₂ ⁽²⁾
0215 ₁₆	CAN0 Error Interrupt Status Register	C0EISTR	XXXX X000 ₂ ⁽²⁾
0216 ₁₆	CAN0 Error Cause Register	C0EFR	00 ₁₆ ⁽²⁾
0217 ₁₆	CAN0 Baud Rate Prescaler	C0BRP	0000 0001 ₂ ⁽²⁾
0218 ₁₆			
0219 ₁₆	CAN0 Mode Register	C0MDR	XXXX XX00 ₂ ⁽²⁾
021A ₁₆			
021B ₁₆			
021C ₁₆			
021D ₁₆			
021E ₁₆			
021F ₁₆			
0220 ₁₆	CAN0 Single Shot Control Register	C0SSCTLR	00 ₁₆ ⁽²⁾
0221 ₁₆			00 ₁₆ ⁽²⁾
0222 ₁₆			
0223 ₁₆			
0224 ₁₆	CAN0 Single Shot Status Register	C0SSSTR	00 ₁₆ ⁽²⁾
0225 ₁₆			00 ₁₆ ⁽²⁾
0226 ₁₆			
0227 ₁₆			
0228 ₁₆	CAN0 Global Mask Register Standard ID0	C0GMR0	XXX0 0000 ₂ ⁽²⁾
0229 ₁₆	CAN0 Global Mask Register Standard ID1	C0GMR1	XX00 0000 ₂ ⁽²⁾
022A ₁₆	CAN0 Global Mask Register Extended ID0	C0GMR2	XXXX 0000 ₂ ⁽²⁾
022B ₁₆	CAN0 Global Mask Register Extended ID1	C0GMR3	00 ₁₆ ⁽²⁾
022C ₁₆	CAN0 Global Mask Register Extended ID2	C0GMR4	XX00 0000 ₂ ⁽²⁾
022D ₁₆			
022E ₁₆			
022F ₁₆			
0230 ₁₆	CAN0 Message Slot 0 Control Register / CAN0 Local Mask Register A Standard ID0	C0MCTL0/ C0LMAR0	0000 0000 ₂ ⁽²⁾ XXX0 0000 ₂ ⁽²⁾
0231 ₁₆	CAN0 Message Slot 1 Control Register / CAN0 Local Mask Register A Standard ID1	C0MCTL1/ C0LMAR1	0000 0000 ₂ ⁽²⁾ XX00 0000 ₂ ⁽²⁾
0232 ₁₆	CAN0 Message Slot 2 Control Register / CAN0 Local Mask Register A Extended ID0	C0MCTL2/ C0LMAR2	0000 0000 ₂ ⁽²⁾ XXXX 0000 ₂ ⁽²⁾
0233 ₁₆	CAN0 Message Slot 3 Control Register / CAN0 local Mask Register A Extended ID1	C0MCTL3/ C0LMAR3	00 ₁₆ ⁽²⁾ 00 ₁₆ ⁽²⁾
0234 ₁₆	CAN0 Message Slot 4 Control Register / CAN0 Local Mask Register A Extended ID2	C0MCTL4/ C0LMAR4	0000 0000 ₂ ⁽²⁾ XX00 0000 ₂ ⁽²⁾
0235 ₁₆	CAN0 Message Slot 5 Control Register	C0MCTL5	00 ₁₆ ⁽²⁾
0236 ₁₆	CAN0 Message Slot 6 Control Register	C0MCTL6	00 ₁₆ ⁽²⁾
0237 ₁₆	CAN0 Message Slot 7 Control Register	C0MCTL7	00 ₁₆ ⁽²⁾
0238 ₁₆	CAN0 Message Slot 8 Control Register / CAN0 Local Mask Register B Standard ID0	C0MCTL8/ C0LMBR0	0000 0000 ₂ ⁽²⁾ XXX0 0000 ₂ ⁽²⁾
0239 ₁₆	CAN0 Message Slot 9 Control Register / CAN0 Local Mask Register B Standard ID1	C0MCTL9/ C0LMBR1	0000 0000 ₂ ⁽²⁾ XX00 0000 ₂ ⁽²⁾

(Note 1)

X: Indeterminate

Blank spaces are reserved. No access is allowed.

NOTES:

1. The BANKSEL bit in the C0CTLR1 register switches functions for addresses 0220₁₆ to 023F₁₆.
2. Values are obtained by setting the SLEEP bit in the C0SLPR register to "1" (sleep mode exited) after reset and applying the clock to the CAN module.

Address	Register	Symbol	Value after RESET
02E0 ₁₆	X/Y Control Register	XYC	XXXX XX00 ₂
02E1 ₁₆			
02E2 ₁₆			
02E3 ₁₆			
02E4 ₁₆	UART1 Special Mode Register 4	U1SMR4	00 ₁₆
02E5 ₁₆	UART1 Special Mode Register 3	U1SMR3	00 ₁₆
02E6 ₁₆	UART1 Special Mode Register 2	U1SMR2	00 ₁₆
02E7 ₁₆	UART1 Special Mode Register	U1SMR	00 ₁₆
02E8 ₁₆	UART1 Transmit/Receive Mode Register	U1MR	00 ₁₆
02E9 ₁₆	UART1 Bit Rate Register	U1BRG	XX ₁₆
02EA ₁₆	UART1 Transmit Buffer Register	U1TB	XX ₁₆
02EB ₁₆			XX ₁₆
02EC ₁₆	UART1 Transmit/Receive Control Register 0	U1C0	0000 1000 ₂
02ED ₁₆	UART1 Transmit/Receive Control Register 1	U1C1	0000 0010 ₂
02EE ₁₆	UART1 Receive Buffer Register	U1RB	XX ₁₆
02EF ₁₆			XX ₁₆
02F0 ₁₆			
02F1 ₁₆			
02F2 ₁₆			
02F3 ₁₆			
02F4 ₁₆	UART4 Special Mode Register 4	U4SMR4	00 ₁₆
02F5 ₁₆	UART4 Special Mode Register 3	U4SMR3	00 ₁₆
02F6 ₁₆	UART4 Special Mode Register 2	U4SMR2	00 ₁₆
02F7 ₁₆	UART4 Special Mode Register	U4SMR	00 ₁₆
02F8 ₁₆	UART4 Transmit/Receive Mode Register	U4MR	00 ₁₆
02F9 ₁₆	UART4 Bit Rate Register	U4BRG	XX ₁₆
02FA ₁₆	UART4 Transmit Buffer Register	U4TB	XX ₁₆
02FB ₁₆			XX ₁₆
02FC ₁₆	UART4 Transmit/Receive Control Register 0	U4C0	0000 1000 ₂
02FD ₁₆	UART4 Transmit/Receive Control Register 1	U4C1	0000 0010 ₂
02FE ₁₆	UART4 Receive Buffer Register	U4RB	XX ₁₆
02FF ₁₆			XX ₁₆
0300 ₁₆	Timer B3, B4, B5 Count Start Flag	TBSR	000X XXXX ₂
0301 ₁₆			
0302 ₁₆	Timer A1-1 Register	TA11	XX ₁₆
0303 ₁₆			XX ₁₆
0304 ₁₆	Timer A2-1 Register	TA21	XX ₁₆
0305 ₁₆			XX ₁₆
0306 ₁₆	Timer A4-1 Register	TA41	XX ₁₆
0307 ₁₆			XX ₁₆
0308 ₁₆	Three-Phase PWM Control Register 0	INVC0	00 ₁₆
0309 ₁₆	Three-Phase PWM Control Register 1	INVC1	00 ₁₆
030A ₁₆	Three-Phase Output Buffer Register 0	IDB0	XX11 1111 ₂
030B ₁₆	Three-Phase Output Buffer Register 1	IDB1	XX11 1111 ₂
030C ₁₆	Dead Time Timer	DTT	XX ₁₆
030D ₁₆	Timer B2 Interrupt Generation Frequency Set Counter	ICTB2	XX ₁₆
030E ₁₆			
030F ₁₆			

X: Indeterminate

Blank spaces are reserved. No access is allowed.

Address	Register	Symbol	Value after RESET
0310 ₁₆ 0311 ₁₆	Timer B3 Register	TB3	XX ₁₆ XX ₁₆
0312 ₁₆ 0313 ₁₆	Timer B4 Register	TB4	XX ₁₆ XX ₁₆
0314 ₁₆ 0315 ₁₆	Timer B5 Register	TB5	XX ₁₆ XX ₁₆
0316 ₁₆			
0317 ₁₆			
0318 ₁₆			
0319 ₁₆			
031A ₁₆			
031B ₁₆	Timer B3 Mode Register	TB3MR	00XX 0000 ₂
031C ₁₆	Timer B4 Mode Register	TB4MR	00XX 0000 ₂
031D ₁₆	Timer B5 Mode Register	TB5MR	00XX 0000 ₂
031E ₁₆			
031F ₁₆	External Interrupt Request Source Select Register	IFSR	00 ₁₆
0320 ₁₆			
0321 ₁₆			
0322 ₁₆			
0323 ₁₆			
0324 ₁₆	UART3 Special Mode Register 4	U3SMR4	00 ₁₆
0325 ₁₆	UART3 Special Mode Register 3	U3SMR3	00 ₁₆
0326 ₁₆	UART3 Special Mode Register 2	U3SMR2	00 ₁₆
0327 ₁₆	UART3 Special Mode Register	U3SMR	00 ₁₆
0328 ₁₆	UART3 Transmit/Receive Mode Register	U3MR	00 ₁₆
0329 ₁₆	UART3 Bit Rate Register	U3BRG	XX ₁₆
032A ₁₆ 032B ₁₆	UART3 Transmit Buffer Register	U3TB	XX ₁₆ XX ₁₆
032C ₁₆	UART3 Transmit/Receive Control Register 0	U3C0	0000 1000 ₂
032D ₁₆	UART3 Transmit/Receive Control Register 1	U3C1	0000 0010 ₂
032E ₁₆ 032F ₁₆	UART3 Receive Buffer Register	U3RB	XX ₁₆ XX ₁₆
0330 ₁₆			
0331 ₁₆			
0332 ₁₆			
0333 ₁₆			
0334 ₁₆	UART2 Special Mode Register 4	U2SMR4	00 ₁₆
0335 ₁₆	UART2 Special Mode Register 3	U2SMR3	00 ₁₆
0336 ₁₆	UART2 Special Mode Register 2	U2SMR2	00 ₁₆
0337 ₁₆	UART2 Special Mode Register	U2SMR	00 ₁₆
0338 ₁₆	UART2 Transmit/Receive Mode Register	U2MR	00 ₁₆
0339 ₁₆	UART2 Bit Rate Register	U2BRG	XX ₁₆
033A ₁₆ 033B ₁₆	UART2 Transmit Buffer Register	U2TB	XX ₁₆ XX ₁₆
033C ₁₆	UART2 Transmit/Receive Control Register 0	U2C0	0000 1000 ₂
033D ₁₆	UART2 Transmit/Receive Control Register 1	U2C1	0000 0010 ₂
033E ₁₆ 033F ₁₆	UART2 Receive Buffer Register	U2RB	XX ₁₆ XX ₁₆

X: Indeterminate

Blank spaces are reserved. No access is allowed.

$$V_{CC1}=V_{CC2}=5V$$

Table 5.3 Electrical Characteristics (Continued)

($V_{CC1}=V_{CC2}=4.2$ to $5.5V$, $V_{SS}=0V$ at $T_{opr} = -20$ to $85^{\circ}C$, $f(BCLK)=32MHz$ unless otherwise specified)

Symbol	Parameter	Measurement Condition		Standard			Unit
				Min.	Typ.	Max.	
I _{cc}	Power Supply Current	In single-chip mode, output pins are left open and other pins are connected to V _{SS} .	f(BCLK)=32 MHz, Square wave, No division		28	45	mA
			f(BCLK)=32 kHz, In low-power consumption mode, Program running on ROM		430		μA
			Flash Memory Masked ROM		25		
			f(BCLK)=32 kHz, In low-power consumption mode, Program running on RAM ⁽¹⁾		25		μA
			f(BCLK)=32 kHz, In wait mode, T _{opr} =25° C		10		μA
			While clock stops, T _{opr} =25° C		0.8	5	μA
			While clock stops, T _{opr} =85° C			50	μA

NOTES:

1. Value is obtained when setting the FMSTP bit in the FMR0 register to "1" (flash memory stopped).

$$V_{CC1}=V_{CC2}=5V$$

Table 5.4 A/D Conversion Characteristics ($V_{CC1}=V_{CC2}=AV_{CC}=V_{REF}=4.2$ to $5.5V$, $V_{SS}=AV_{SS}=0V$ at $T_{opr}=-20$ to $85^{\circ}C$, $f(BCLK) = 32MHz$ unless otherwise specified)

Symbol	Parameter	Measurement Condition		Standard			Unit
				Min.	Typ.	Max.	
-	Resolution	$V_{REF}=V_{CC1}$				10	Bits
INL	Integral Nonlinearity Error	$V_{REF}=V_{CC1}=V_{CC2}=5V$	AN_0 to AN_7 , AN_{00} to AN_{07} , AN_{20} to AN_{27} , AN_{150} to AN_{157} , $ANEX0$, $ANEX1$			± 3	LSB
			External op-amp connection mode			± 7	LSB
							LSB
DNL	Differential Nonlinearity Error					± 1	LSB
-	Offset Error					± 3	LSB
-	Gain Error					± 3	LSB
RLADDER	Resistor Ladder	$V_{REF}=V_{CC1}$		8		40	k Ω
t _{CONV}	10-bit Conversion Time ^(1, 2)			2.06			μs
t _{CONV}	8-bit Conversion Time ^(1, 2)			1.75			μs
t _{SAMP}	Sampling Time ⁽¹⁾			0.188			μs
V _{REF}	Reference Voltage			2		V_{CC1}	V
V _{IA}	Analog Input Voltage			0		V_{REF}	V

NOTES:

1. Divide $f(X_{IN})$, if exceeding 16 MHz, to keep ϕ_{AD} frequency at 16 MHz or less.
2. With using the sample and hold function.

Table 5.5 D/A Conversion Characteristics ($V_{CC1}=V_{CC2}=V_{REF}=4.2$ to $5.5V$, $V_{SS}=AV_{SS}=0V$ at $T_{opr}=-20$ to $85^{\circ}C$, $f(BCLK) = 32MHz$ unless otherwise specified)

Symbol	Parameter	Measurement Condition	Standard			Unit
			Min.	Typ.	Max.	
-	Resolution				8	Bits
-	Absolute Accuracy				1.0	%
t _{SU}	Setup Time				3	μs
R _O	Output Resistance		4	10	20	k Ω
I _{VREF}	Reference Power Supply Input Current	(Note 1)			1.5	mA

NOTES:

1. Measurement when using one D/A converter. The DA_i register (i=0, 1) of the D/A converter, not being used, is set to "00₁₆". The resistor ladder in the A/D converter is excluded.
I_{VREF} flows even if the VCUT bit in the AD0CON1 register is set to "0" (no V_{REF} connection).

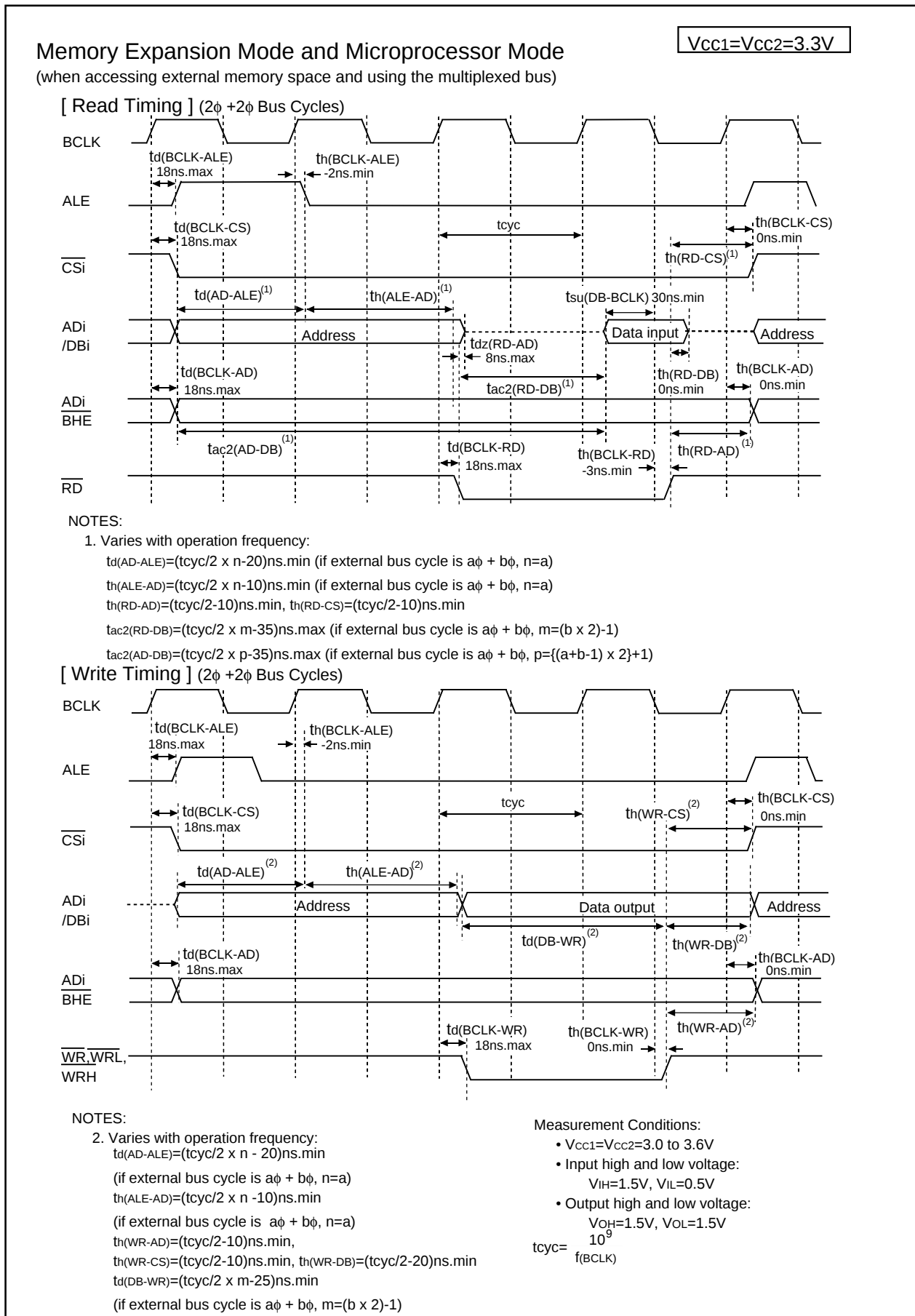
Figure 5.8 $V_{CC1}=V_{CC2}=3.3V$ Timing Diagram (2)

Table 5.43 Recommended Operating Conditions(V_{CC1}=V_{CC2}=4.2 to 5.5V, V_{SS}=0V at T_{opr} = -40 to 85°C (T version) unless otherwise specified)

Symbol	Parameter		Standard			Unit
			Min.	Typ.	Max.	
V _{CC1} , V _{CC2}	Supply Voltage (V _{CC1} ≥ V _{CC2})		4.2	5.0	5.5	V
AV _{CC}	Analog Supply Voltage			V _{CC1}		V
V _{SS}	Supply Voltage			0		V
AV _{SS}	Analog Supply Voltage			0		V
V _{IH}	Input High ("H") Voltage	P20-P27, P30-P37, P40-P47, P50-P57, P110-P114, P120-P127, P130-P137 ⁽⁴⁾	0.8V _{CC2}		V _{CC2}	V
		P60-P67, P72-P77, P80-P87 ⁽³⁾ , P90-P97, P100-P107, P140-P146, P150-P157 ⁽⁴⁾ , X _{IN} , $\overline{\text{RESET}}$, CNV _{SS} , BYTE	0.8V _{CC1}		V _{CC1}	
		P70, P71	0.8V _{CC1}		6.0	
		P00-P07, P10-P17	0.8V _{CC2}		V _{CC2}	
V _{IL}	Input Low ("L") Voltage	P20-P27, P30-P37, P40-P47, P50-P57, P110-P114, P120-P127, P130-P137 ⁽⁴⁾	0		0.2V _{CC2}	V
		P60-P67, P70-P77, P80-P87 ⁽³⁾ , P90-P97, P100-P107, P140-P146, P150-P157 ⁽⁴⁾ , X _{IN} , $\overline{\text{RESET}}$, CNV _{SS} , BYTE	0		0.2V _{CC1}	
		P00-P07, P10-P17	0		0.2V _{CC2}	
I _{OH(peak)}	Peak Output High ("H") Current ⁽²⁾	P00-P07, P10-P17, P20-P27, P30-P37, P40-P47, P50-P57, P60-P67, P72-P77, P80-P84, P86, P87, P90-P97, P100-P107, P110-P114, P120-P127, P130-P137, P140-P146, P150-P157 ⁽⁴⁾			-10.0	mA
I _{OH(avg)}	Average Output High ("H") Current ⁽¹⁾	P00-P07, P10-P17, P20-P27, P30-P37, P40-P47, P50-P57, P60-P67, P72-P77, P80-P84, P86, P87, P90-P97, P100-P107, P110-P114, P120-P127, P130-P137, P140-P146, P150-P157 ⁽⁴⁾			-5.0	mA
I _{OL(peak)}	Peak Output Low ("L") Current ⁽²⁾	P00-P07, P10-P17, P20-P27, P30-P37, P40-P47, P50-P57, P60-P67, P70-P77, P80-P84, P86, P87, P90-P97, P100-P107, P110-P114, P120-P127, P130-P137, P140-P146, P150-P157 ⁽⁴⁾			10.0	mA
I _{OL(avg)}	Average Output Low ("L") Current ⁽¹⁾	P00-P07, P10-P17, P20-P27, P30-P37, P40-P47, P50-P57, P60-P67, P70-P77, P80-P84, P86, P87, P90-P97, P100-P107, P110-P114, P120-P127, P130-P137, P140-P146, P150-P157 ⁽⁴⁾			5.0	mA

NOTES:

- Typical values when average output current is 100ms.
- Total I_{OL(peak)} for P0, P1, P2, P86, P87, P9, P10, P11, P14 and P15 must be 80mA or less.
Total I_{OL(peak)} for P3, P4, P5, P6, P7, P80 to P84, P12 and P13 must be 80mA or less.
Total I_{OH(peak)} for P0, P1, P2, and P11 must be -40mA or less.
Total I_{OH(peak)} for P86, P87, P9, P10, P14 and P15 must be -40mA or less.
Total I_{OH(peak)} for P3, P4, P5, P12 and P13 must be -40mA or less.
Total I_{OH(peak)} for P6, P7, and P80 to P84 must be -40mA or less.
- V_{IH} and V_{IL} reference for P87 applies when P87 is used as a programmable input port.
It does not apply when P87 is used as X_{CIN}.
- P11 to P15 are provided in the 144-pin package only.

$$V_{CC1}=V_{CC2}=5V$$

Timing Requirements

($V_{CC1}=V_{CC2}=4.2$ to $5.5V$, $V_{SS}=0V$ at $T_{opr}= -40$ to $85^{\circ}C$ (T version) unless otherwise specified)

Table 5.49 External Clock Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
t_c	External Clock Input Cycle Time	31.25		ns
$t_{w(H)}$	External Clock Input High ("H") Width	13.75		ns
$t_{w(L)}$	External Clock Input Low ("L") Width	13.75		ns
t_r	External Clock Rise Time		5	ns
t_f	External Clock Fall Time		5	ns

$$V_{CC1}=V_{CC2}=5V$$

Timing Requirements

($V_{CC1}=V_{CC2}=4.2$ to $5.5V$, $V_{SS}=0V$ at $T_{opr}= -40$ to $85^{\circ}C$ (T version) unless otherwise specified)

Table 5.55 Timer B Input (Count Source Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{C(TB)}$	TB _{IN} Input Cycle Time (counted on one edge)	100		ns
$t_{W(TBH)}$	TB _{IN} Input High ("H") Width (counted on one edge)	40		ns
$t_{W(TBL)}$	TB _{IN} Input Low ("L") Width (counted on one edge)	40		ns
$t_{C(TB)}$	TB _{IN} Input Cycle Time (counted on both edges)	200		ns
$t_{W(TBH)}$	TB _{IN} Input High ("H") Width (counted on both edges)	80		ns
$t_{W(TBL)}$	TB _{IN} Input Low ("L") Width (counted on both edges)	80		ns

Table 5.56 Timer B Input (Pulse Period Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{C(TB)}$	TB _{IN} Input Cycle Time	400		ns
$t_{W(TBH)}$	TB _{IN} Input High ("H") Width	200		ns
$t_{W(TBL)}$	TB _{IN} Input Low ("L") Width	200		ns

Table 5.57 Timer B Input (Pulse Width Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{C(TB)}$	TB _{IN} Input Cycle Time	400		ns
$t_{W(TBH)}$	TB _{IN} Input High ("H") Width	200		ns
$t_{W(TBL)}$	TB _{IN} Input Low ("L") Width	200		ns

Table 5.58 A/D Trigger Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{C(AD)}$	AD _{TRG} Input Cycle Time (required for trigger)	1000		ns
$t_{W(ADL)}$	AD _{TRG} Input Low ("L") Pulse Width	125		ns

Table 5.59 Serial I/O

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{C(CK)}$	CLK _I Input Cycle Time	200		ns
$t_{W(CKH)}$	CLK _I Input High ("H") Width	100		ns
$t_{W(CKL)}$	CLK _I Input Low ("L") Width	100		ns
$t_{d(C-Q)}$	TxD _I Output Delay Time		80	ns
$t_{h(C-Q)}$	TxD _I Hold Time	0		ns
$t_{su(D-C)}$	RxD _I Input Setup Time	30		ns
$t_{h(C-Q)}$	RxD _I Input Hold Time	90		ns

Table 5.60 External Interrupt INT_I Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{W(INH)}$	INT _I Input High ("H") Width	250		ns
$t_{W(INL)}$	INT _I Input Low ("L") Width	250		ns

REVISION HISTORY	M32C/85 Group (M32C/85, M32C/85T) Datasheet
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Rev.	Date	Description	
		Page	Summary
		65	• Table 5.28 Memory Expansion Mode and Microprocessor Mode $t_{AC1}(AD-DB)$ expression modified
		77	• Table 5.44 Electrical Characteristics I_{CC} standard value revised
		80	• Table 5.47 Flash Memory Electrical Characteristics T_{opr} value modified
1.21	Jul.01, 2005	All pages	Package code changed: 144P6Q-A to PLQP0144KA-A, 100P6Q-A to PLQP0100KB-A, 100P6S-A to PRQP0100JB-A
		All pages	"Low Voltage Detection Reset" changed to "Brown-out Detection Reset"
			Special Function Register (SFR)
		27	• The G0RB register Value after reset modified
		39	• The TCSPR register Value after reset modified
			Electrical Characteristics
		47	• Table 5.2 Electrical Characteristics Parameter $f(BCLK)$ and its values added
		51	• Table 5.6 Flash Memory Version Electrical Characteristics Measurement condition changed
		53	• Table 5.10 Memory Expansion Mode and Microprocessor Mode $t_{AC1}(RD-DB)$ expression on Note 1 modified; $t_{AC2}(RD-DB)$ expression on Note 1 added
		59	• Figure 5.3 Vcc1=Vcc2=5V Timing Diagram (1) $t_{W(ER)}$ expression on Note 3 modified; t_{CYC} expression added
		60	• Figure 5.4 Vcc1=Vcc2=5V Timing Diagram (2) $t_{AC2}(AD-DB)$ expression on Note 1 modified; $t_{H(ALE-AD)}$ expressions on Notes 1 and 2 modified; t_{CYC} expression added
		65	• Table 5.28 Memory Expansion Mode and Microprocessor Mode $t_{AC1}(RD-DB)$ expression on Note 1 modified; $t_{AC2}(RD-DB)$ expression on Note 1 added
		70	• Figure 5.7 Vcc1=Vcc2=3.3V Timing Diagram (1) $t_{W(ER)}$ expression on Note 3 modified; t_{CYC} expression added
		71	• Figure 5.8 Vcc1=Vcc2=3.3V Timing Diagram (2) $t_{AC2}(RD-DB)$ expression on Note 1 modified; $t_{H(ALE-AD)}$ expressions on Notes 1 and 2 modified; $t_{H(WR-CS)}$ expression on Note 2 modified; t_{CYC} expression added
		76	• Table 5.43 Electrical Characteristics Parameter $f(BCLK)$ and its values added
		80	• Table 5.47 Flash Memory Version Electrical Characteristics Measurement condition changed